

SMCG Plastic-Encapsulate Diodes

SK32 THRU SK320 Schottky Rectifier Diodes

Features

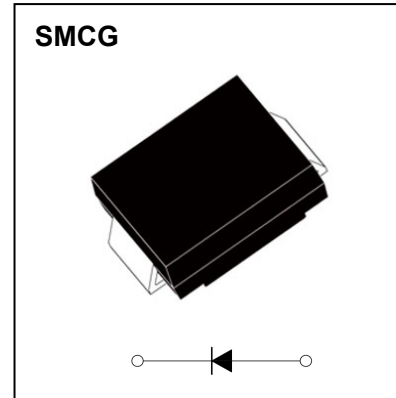
- $I_{F(AV)}$ 3A
- V_{RRM} 20V-200V
- High surge current capability
- Polarity: Color band denotes cathode

Applications

- Rectifier

Marking

- SK3X
X : From 2 To 20



Limiting Values(Absolute Maximum Rating)

| Item | Symbol | Unit | Test Conditions | SK3 | | | | | | | | | | | | | | | |
|--------------------------------------|-------------|------------------|--|------------|----|----|----|----|----|-----|-----|-----|--|--|--|--|--|--|--|
| | | | | 2 | 3 | 4 | 5 | 6 | 8 | 10 | 15 | 20 | | | | | | | |
| Repetitive Peak Reverse Voltage | V_{RRM} | V | | 20 | 30 | 40 | 50 | 60 | 80 | 100 | 150 | 200 | | | | | | | |
| Maximum RMS Voltage | V_{RMS} | V | | 14 | 21 | 28 | 35 | 42 | 56 | 70 | 105 | 140 | | | | | | | |
| Average Forward Current | $I_{F(AV)}$ | A | 60Hz Half-sine wave, Resistance load | 3.0 | | | | | | | | | | | | | | | |
| Surge(Non-repetitive)Forward Current | I_{FSM} | A | 60Hz Half-sine wave, 1 cycle, $T_a=25^\circ\text{C}$ | 100 | | | | | | | | | | | | | | | |
| Junction Temperature | T_J | $^\circ\text{C}$ | | -55~+150 | | | | | | | | | | | | | | | |
| Storage Temperature | T_{STG} | $^\circ\text{C}$ | | -55 ~ +150 | | | | | | | | | | | | | | | |

Electrical Characteristics ($T = 25^\circ\text{C}$ Unless otherwise specified)

| Item | Symbol | Unit | Test Condition | SK3 | | | | | | | | | | | | | | | |
|-------------------------------|------------------|--------------------|---|-------------------------|-----|-----|-----|------|----|------|----|----|----|--|--|--|--|--|--|
| | | | | 2 | 3 | 4 | 5 | 6 | 8 | 10 | 15 | 20 | | | | | | | |
| Peak Forward Voltage | V_F | V | $I_F=3.0\text{A}$ | 0.55 | | 0.7 | | 0.85 | | 0.95 | | | | | | | | | |
| Peak Reverse Current | I_{RRM1} | mA | $V_{RM}=V_{RRM}$ | $T_a=25^\circ\text{C}$ | | 0.5 | | | | 0.1 | | | | | | | | | |
| | I_{RRM2} | | | $T_a=100^\circ\text{C}$ | | 10 | | | | 5.0 | | | | | | | | | |
| Thermal Resistance(Typical) | $R_{\theta J-A}$ | $^\circ\text{C/W}$ | Between junction and ambient | | 90 | | | | | | | | | | | | | | |
| | $R_{\theta J-L}$ | | Between junction and terminal | | 9 | | | | | | | | | | | | | | |
| Juction Capacitance (Typical) | C_j | pF | Measured at 1MHZ and Applied Reverse Voltage of 4.0 V.D.C | | 178 | | 134 | | 85 | | 66 | | 57 | | | | | | |

Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on 1" x 1"(25.4mm x 25.4mm) FR4 PCB, double sided copper, with minimum pad layout

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

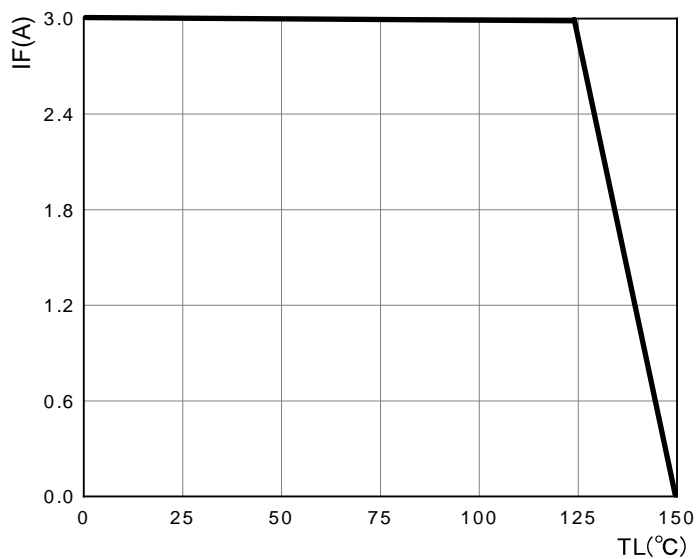
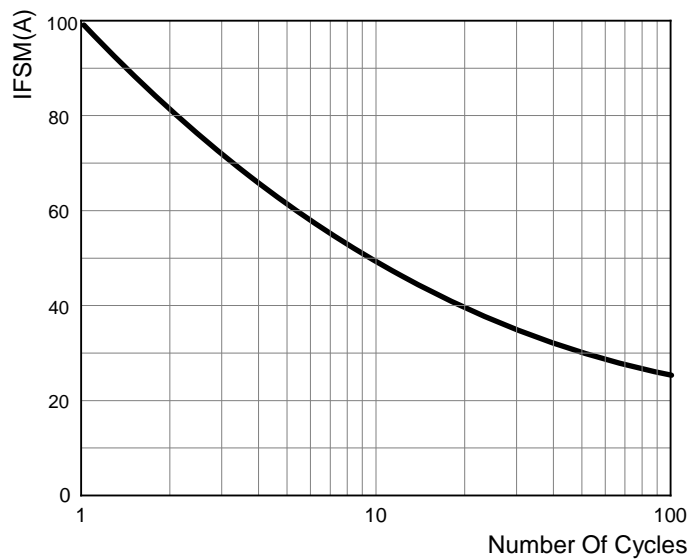
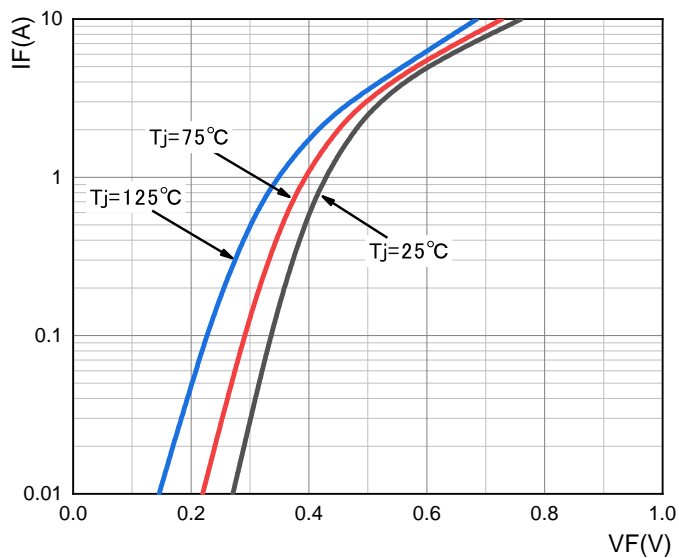


FIG.2: MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT



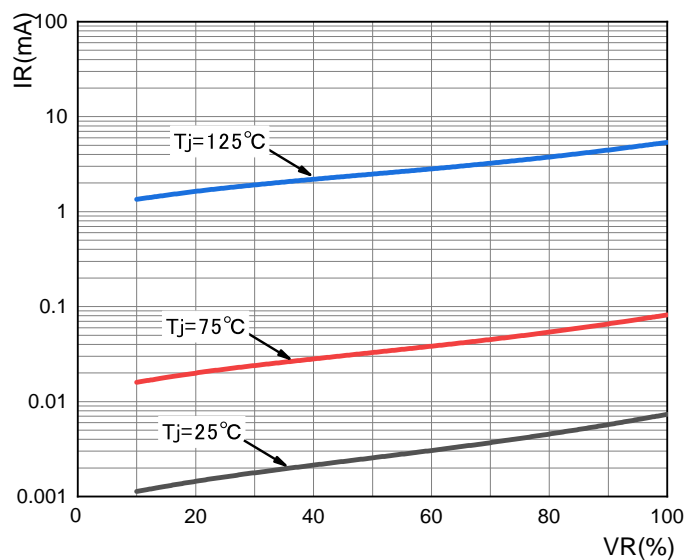
SK32-SK34

FIG.3: TYPICAL FORWARD CHARACTERISTICS



SK32-SK34

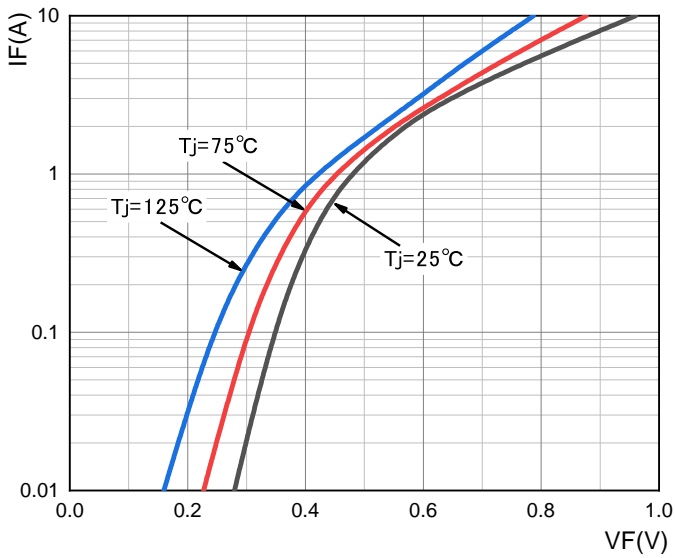
FIG.4: TYPICAL REVERSE CHARACTERISTICS



Typical Characteristics

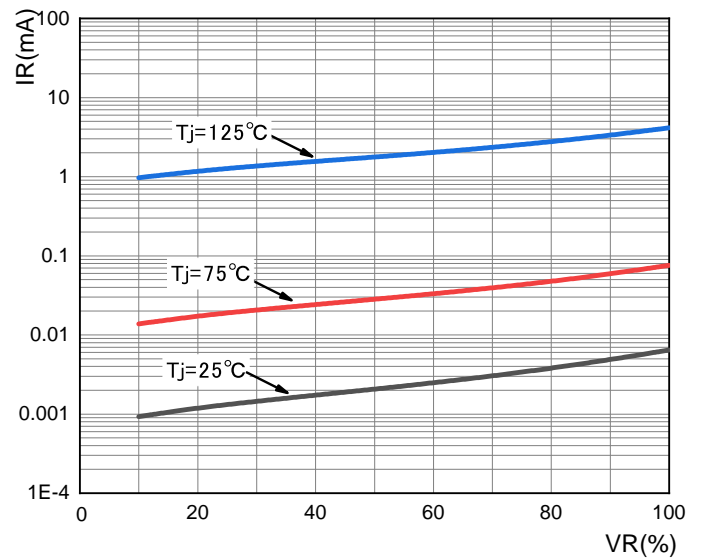
SK35-SK36

FIG.5: TYPICAL FORWARD CHARACTERISTICS



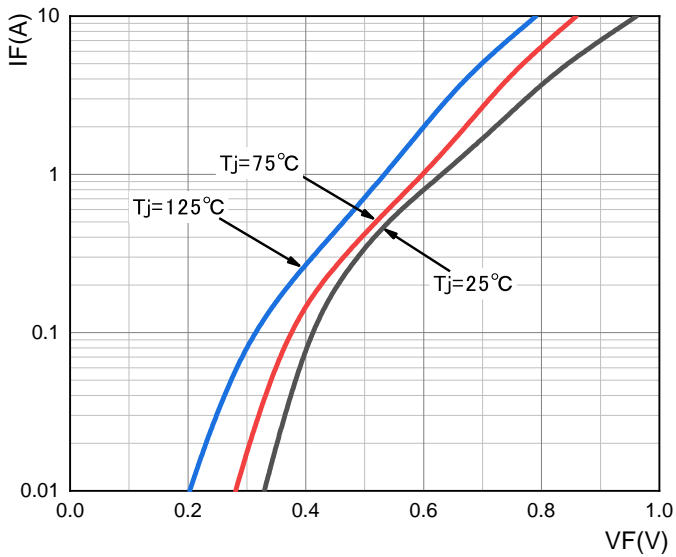
SK35-SK36

FIG.6: TYPICAL REVERSE CHARACTERISTICS



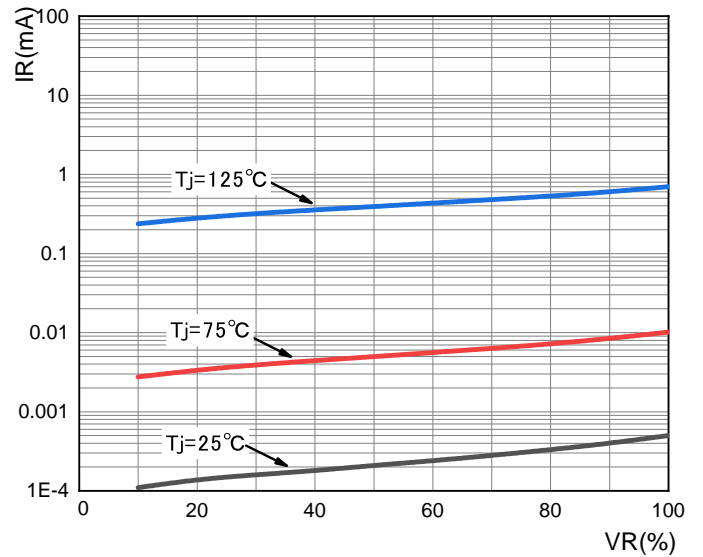
SK38-SK310

FIG.7: TYPICAL FORWARD CHARACTERISTICS



SK38-SK310

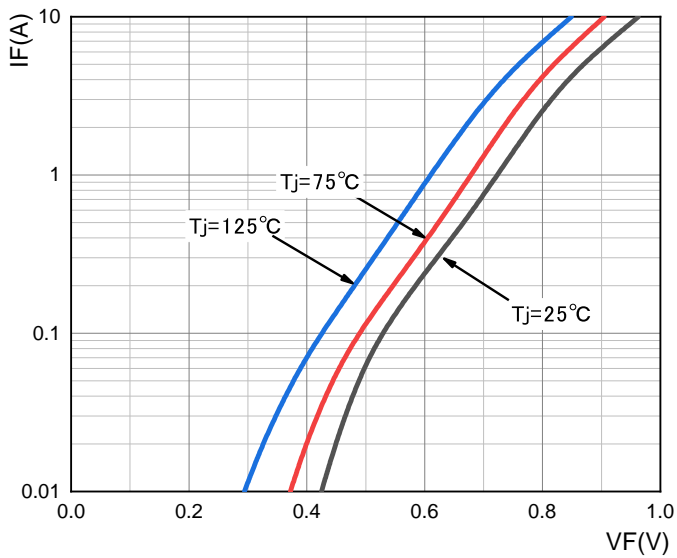
FIG.8: TYPICAL REVERSE CHARACTERISTICS



Typical Characteristics

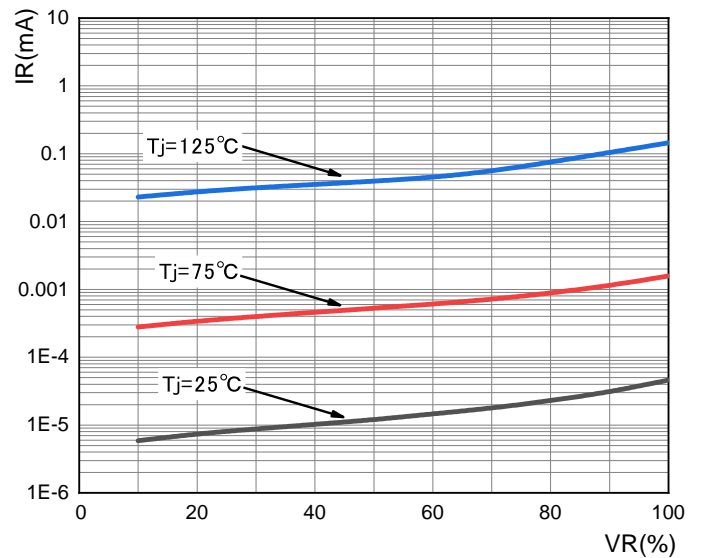
SK315

FIG.9: TYPICAL FORWARD CHARACTERISTICS



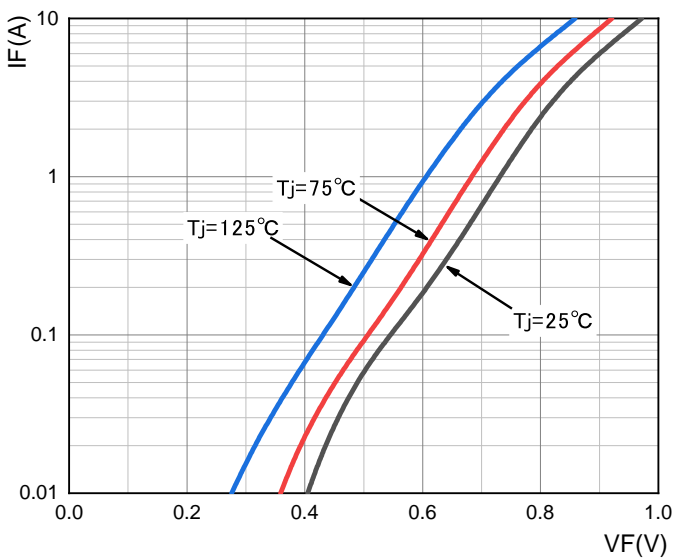
SK315

FIG.10: TYPICAL REVERSE CHARACTERISTICS



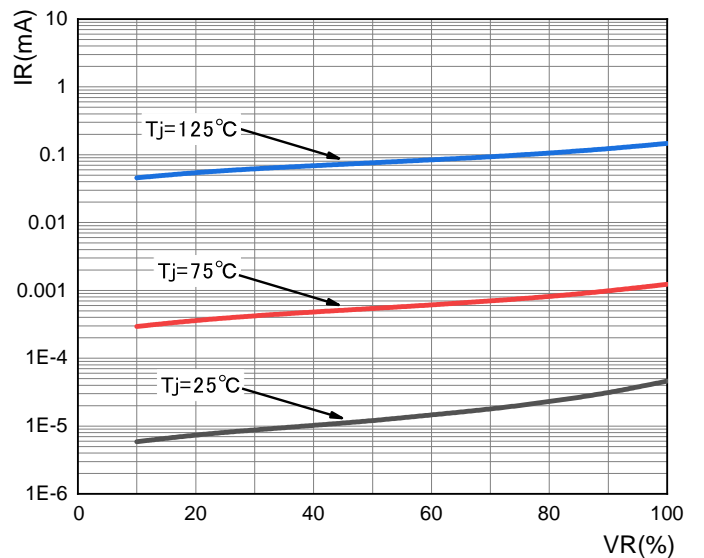
SK320

FIG.11: TYPICAL FORWARD CHARACTERISTICS

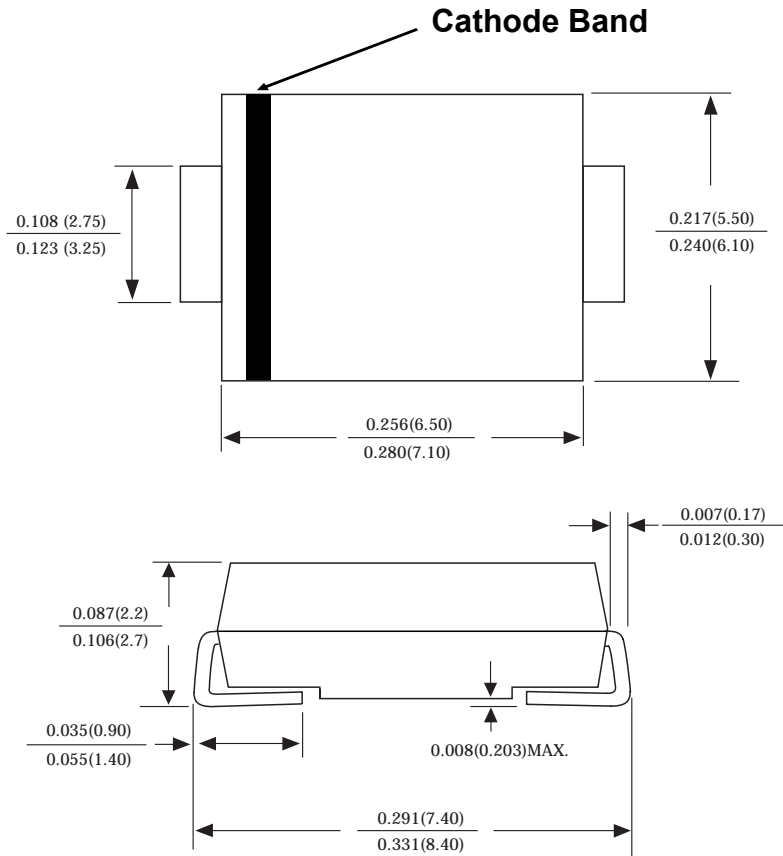


SK320

FIG.12: TYPICAL REVERSE CHARACTERISTICS

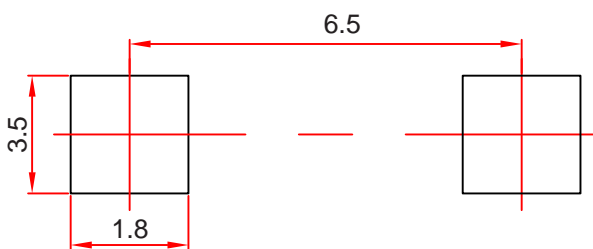


SMCG Package Outline Dimensions



Dimensions in inches and (millimeters)

SMCG Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

NOTICE

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Reel Taping Specifications For Surface Mount Devices-SMCG

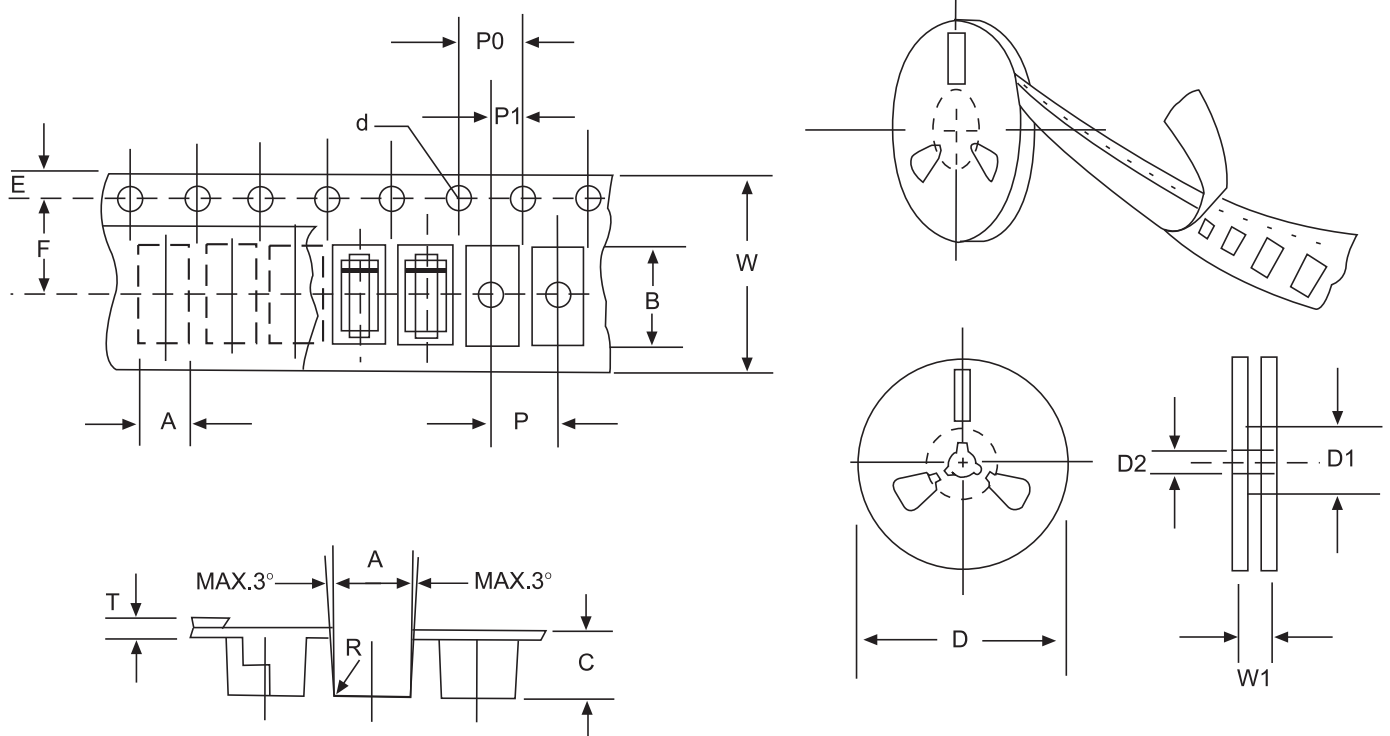


FIG: CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

| ITEM | SYMBOL | SMCG mm(inch) |
|------------------------|--------|------------------------|
| Carrier width | A | 6.05±0.1(0.238±0.004) |
| Carrier length | B | 8.31±0.1(0.327±0.004) |
| Carrier depth | C | 2.70±0.1(0.106±0.004) |
| Sprocket hole | d | 1.55±0.05(0.061±0.002) |
| Reel outside diameter | D | 330±2.0(13±0.079) |
| Reel inner diameter | D1 | 75 ±1.0 (2.95 ±0.039) |
| Feed hole diameter | D2 | 13±0.5(0.512±0.020) |
| Sprocket hole position | E | 1.75±0.1(0.069±0.004) |
| Punch hole position | F | 7.65±0.05(0.301±0.002) |
| Punch hole pitch | P | 8.0±0.1(0.315±0.004) |
| Sprocket hole pitch | P0 | 4.0±0.1(0.157±0.004) |
| Embossment center | P1 | 2.0±0.1(0.079±0.004) |
| Total tape thickness | T | 0.3±0.1(0.012±0.004) |
| Tape width | W | 16.0±0.2(0.630±0.008) |
| Reel width | W1 | 24.0±2.0(0.945±0.079) |

NOTE: Devices are packed in accordance with EIA standard RS-481-A and specification given above.